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INSTRUCTIONS

MODELS AVX-TRR-TESB

TEST JIG FOR USE WITH

AVTECH AVR-EB4-B

REVERSE RECOVERY TEST SYSTEMS

SERIAL NUMBER: _____

WARRANTY

Avtech Electrosystems Ltd. warrants products of its manufacture to be free from defects in material and workmanship under conditions of normal use. If, within one year after delivery to the original owner, and after prepaid return by the original owner, this Avtech product is found to be defective, Avtech shall at its option repair or replace said defective item. This warranty does not apply to units which have been disassembled, modified or subjected to conditions exceeding the applicable specifications or ratings. This warranty is the extent of the obligation assumed by Avtech with respect to this product and no other warranty or guarantee is either expressed or implied.

TECHNICAL SUPPORT

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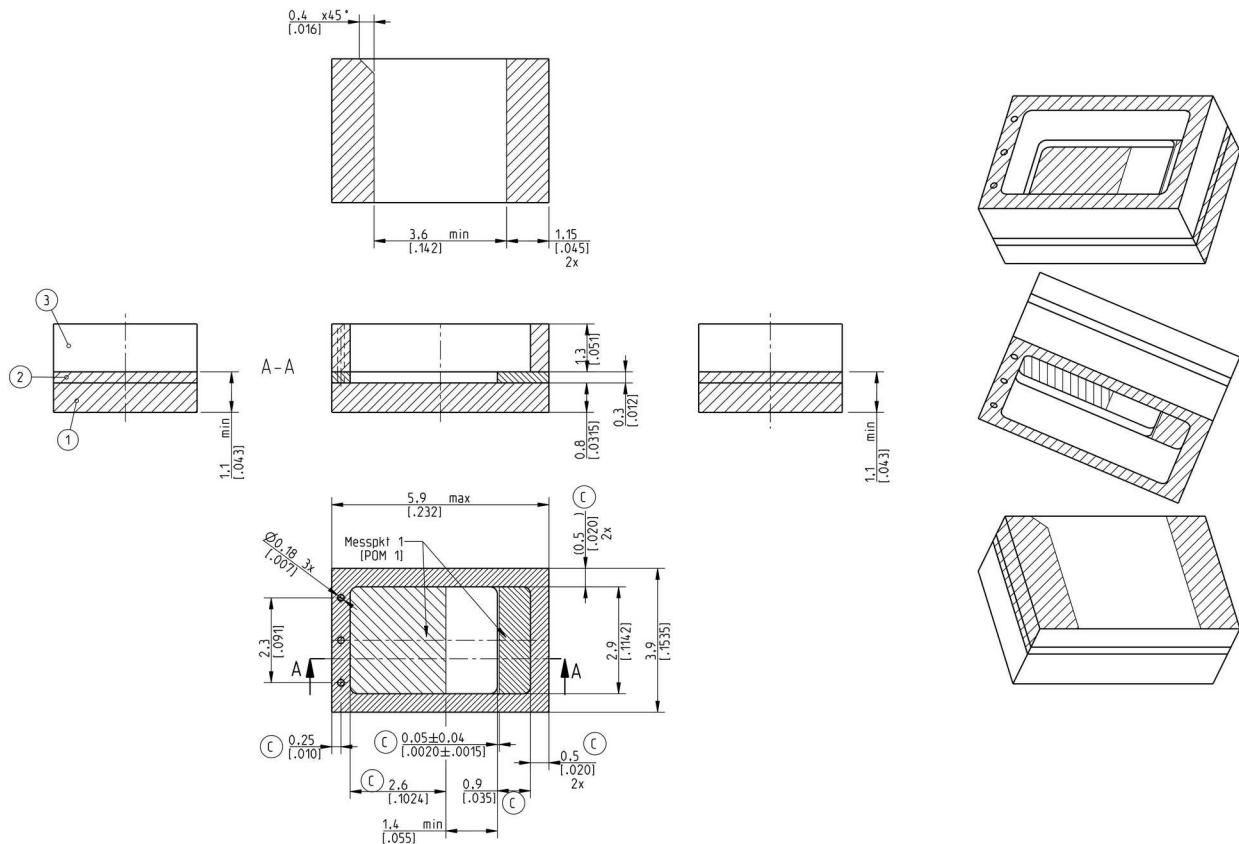
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Manual Reference: /files/server1/officefiles/instructword/avx-trr/AVX-TRR-TESEB,ed1.odt.
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INTRODUCTION

The AVX-TRR-TESB test jig is designed for use with the AVR-EB4-B series of reverse recovery time test systems, and it is designed to accept the customer-specified ceramic package shown below:



Probe points on the jig contact the two 1.15 x 3.9 mm pads on the flat bottom surface of the package. One of these pads must connect internally to the device anode, and one to the device cathode.

The circuit board is constructed from “high Tg” FR4 epoxy (Tg = 170°C).

This test jig can be used as a replacement or an alternative for the test jigs originally supplied with the Avtech AVR-EB4-B units.

REGULATORY NOTES

FCC PART 18

This device complies with part 18 of the FCC rules for non-consumer industrial, scientific and medical (ISM) equipment.

This instrument is enclosed in a rugged metal chassis and uses a filtered power entry module (where applicable). The main output signal is provided on a shielded connector that is intended to be used with shielded coaxial cabling and a shielded load. Under these conditions, the interference potential of this instrument is low.

If interference is observed, check that appropriate well-shielded cabling is used on the output connectors. Contact Avtech (info@avtechpulse.com) for advice if you are unsure of the most appropriate cabling. Also, check that your load is adequately shielded. It may be necessary to enclose the load in a metal enclosure.

If any of the connectors on the instrument are unused, they should be covered with shielded metal "dust caps" to reduce the interference potential.

This instrument does not normally require regular maintenance to minimize interference potential. However, if loose hardware or connectors are noted, they should be tightened. Contact Avtech (info@avtechpulse.com) if you require assistance.

EC DECLARATION OF CONFORMITY



We Avtech Electrosystems Ltd.
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declare that this pulse generator meets the intent of Directive 2004/108/EG for Electromagnetic Compatibility. Compliance pertains to the following specifications as listed in the official Journal of the European Communities:

EN 50081-1 Emission

EN 50082-1 Immunity

and that this pulse generator meets the intent of the Low Voltage Directive 72/23/EEC as amended by 93/68/EEC. Compliance pertains to the following specifications as listed in the official Journal of the European Communities:

EN 61010-1:2001 Safety requirements for electrical equipment for measurement, control, and laboratory use

DIRECTIVE 2002/95/EC (RoHS)

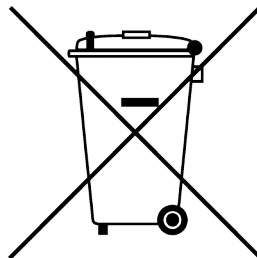
This instrument is exempt from Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the Restriction of the use of certain Hazardous Substances (RoHS) in electrical and electronic equipment. Specifically, Avtech instruments are considered "Monitoring and control instruments" (Category 9) as defined in Annex 1A of Directive 2002/96/EC. The Directive 2002/95/EC only applies to Directive 2002/96/EC categories 1-7 and 10, as stated in the "Article 2 - Scope" section of Directive 2002/95/EC.

DIRECTIVE 2002/96/EC (WEEE)

European customers who have purchased this equipment directly from Avtech will have completed a "WEEE Responsibility Agreement" form, accepting responsibility for WEEE compliance (as mandated in Directive 2002/96/EC of the European Union and local laws) on behalf of the customer, as provided for under Article 9 of Directive 2002/96/EC.

Customers who have purchased Avtech equipment through local representatives should consult with the representative to determine who has responsibility for WEEE compliance. Normally, such responsibilities will lie with the representative, unless other arrangements (under Article 9) have been made.

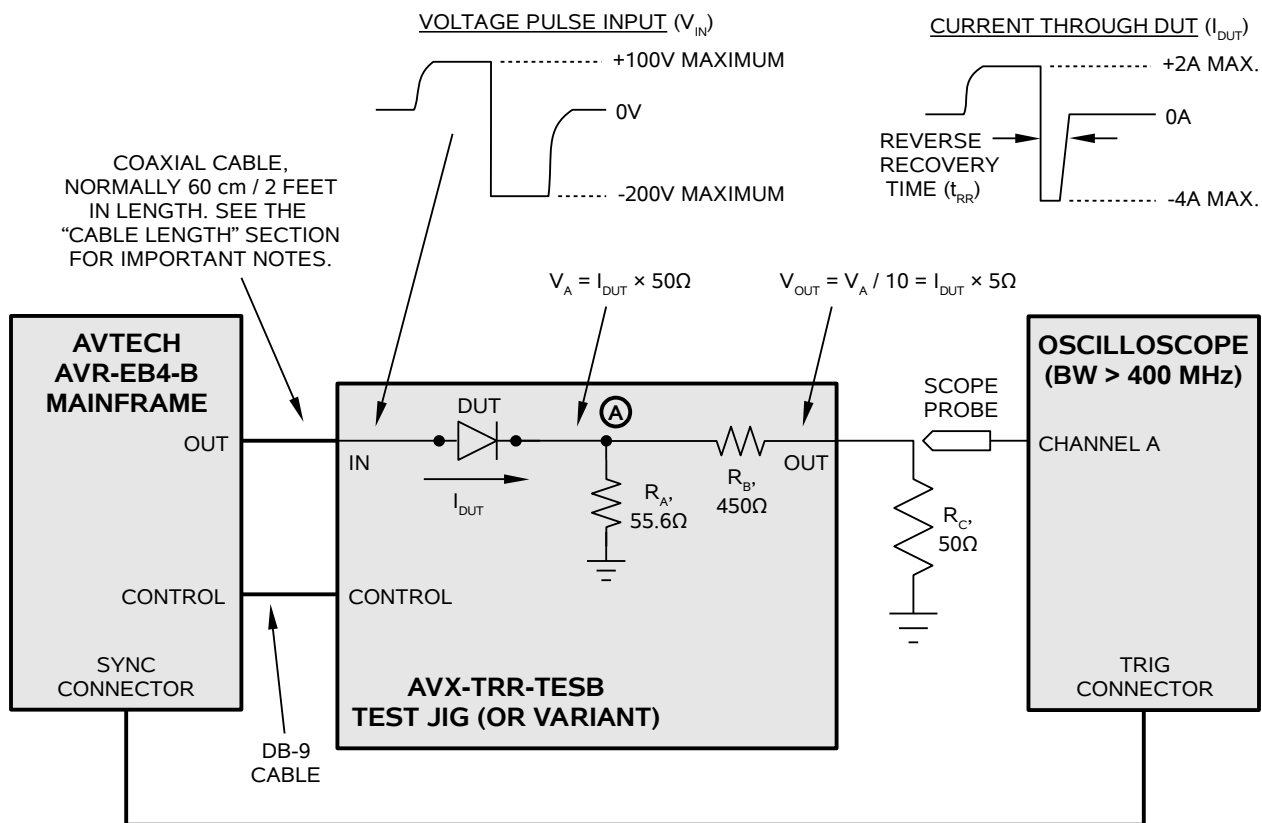
Requirements for WEEE compliance may include registration of products with local governments, reporting of recycling activities to local governments, and financing of recycling activities.



BASIC AMPLITUDE CONTROL

The AVX-TRR-TESB is intended for use with an Avtech AVR-EB4-B reverse recovery test system, ordered separately. Please refer to the manual supplied with the AVR-EB4-B instrument for detailed usage instructions.

An example configuration suitable for use with the AVR-EB4-B is shown in the figure below. The PULSE output on the instrument mainframe is connected to the PULSE input on the test jig using BNC-to-SMA coaxial cable, and the control cable is connected using the supplied DB-9 cable. (The cables are supplied with the AVR-EB4-B.)



⚠ A 50 Ohm resistance (R_C in the diagram above) must be connected to ground on the output. This can be a discrete resistor, a feed-through terminator, or the input impedance of an oscilloscope. If a high-speed sampling oscilloscope is used, the input should be protected by adding attenuator on the input.

The total effective resistance of resistors R_A , R_B , and R_C in the diagram above is 50 Ohms. Thus, the voltage at point "A" is simply given by:

$$V_A = I_{DUT} \times 50\Omega$$

where I_{DUT} is the current through the device under test. A 450 Ohm resistance (R_B) is present in series with the measurement output. When a 50 Ohm resistance (R_C) is installed on the output (by the user), the output voltage will be one-tenth of V_A due to the resistor-divider effect. That is:

$$V_{OUT} = V_A / 10 = I_{DUT} \times 5\Omega$$

This is the key equation for relating the observed voltage waveform to the DUT current.

SETTING THE AMPLITUDE LEVELS

The amplitude of the positive and negative portions of the PULSE waveform may be set from the front panel of the AVR-EB4-B instrument, or by computer command. These settings are expressed in terms of the voltage present on the test jig input.

The positive voltage ("AMP1" on the front panel display) is related to the forward diode current by:

$$I_{FORWARD} \approx (AMP1 - V_F) / (50\Omega + R_{DIODE-FORWARD})$$

where V_F is the forward voltage drop of the diode (typically 0.7V for the classic silicon PN junction diode, and usually somewhat lower for a Schottky diode), and $R_{DIODE-FORWARD}$ is the effective resistance of the diode under forward bias.

The negative voltage ("AMP2" on the front panel display) is related to the reverse diode current by:

$$I_{REVERSE} \approx AMP2 / (50\Omega + R_{DIODE-REVERSE}).$$

Where $R_{DIODE-REVERSE}$ is the effective resistance of the diode under reverse bias.

It is important to note that $R_{DIODE-FORWARD}$ and $R_{DIODE-REVERSE}$ are not the same, and that they may change during the transient. Furthermore, depending on the design of the diode under test, it is possible that $R_{DIODE-REVERSE}$ may be so high that it is impossible to achieve the full 4 Amps of reverse current. (The ideal diode would of course have $R_{DIODE-REVERSE} = \infty$). The reverse voltage can actually be increased to -240V (rather than the nominal maximum of -200V) to increase the likelihood of obtaining the full 4 Amps of reverse current.

Most test procedures for measuring recovery time will use a particular ratio of forward to reverse currents - for example, $I_{REVERSE} / I_{FORWARD} = 2$.

Some Schottky diodes have negligible amounts of stored charge resulting from the forward bias, compared to non-Schottky devices. For these Schottky diodes, the

reverse transient will be governed by the capacitance of the device, and the reverse transient may be largely unaffected by the amplitude of the forward transient. (In other words, the $I_{\text{REVERSE}} / I_{\text{FORWARD}}$ ratio is irrelevant). The capacitance may be so small that it becomes impossible to obtain the full -4 Amps of reverse current.

Normally, the forward and reverse amplitudes should be set near the maximum values (+100V, -200V). Performance may degrade if the amplitudes are set lower than 10% of the maximum values.

AMPLITUDE ACCURACY

Due to the variations in V_F and $R_{\text{DIODE-FORWARD}}$ and $R_{\text{DIODE-REVERSE}}$ as a function of operating conditions, the AMP1 and AMP2 settings *should not be relied upon for any degree of accuracy*. Instead the voltage at the OUT terminal on the test jig should be monitored with a calibrated oscilloscope. As mentioned above, $I_{\text{DUT}} = V / 5\Omega$.


R_A and R_B can be measured directly on the test jig (with the test jig disconnected) to determine calibrated relationships, if desired. R_C is provided by the user, and can be calibrated as required.


INCORRECT ORIENTATION

The instrument and the DUT will not be damaged if the diode is installed with the incorrect orientation (i.e., with the anode and cathode reversed). However, incorrect waveforms will be generated,

ACCESSIBLE VOLTAGES

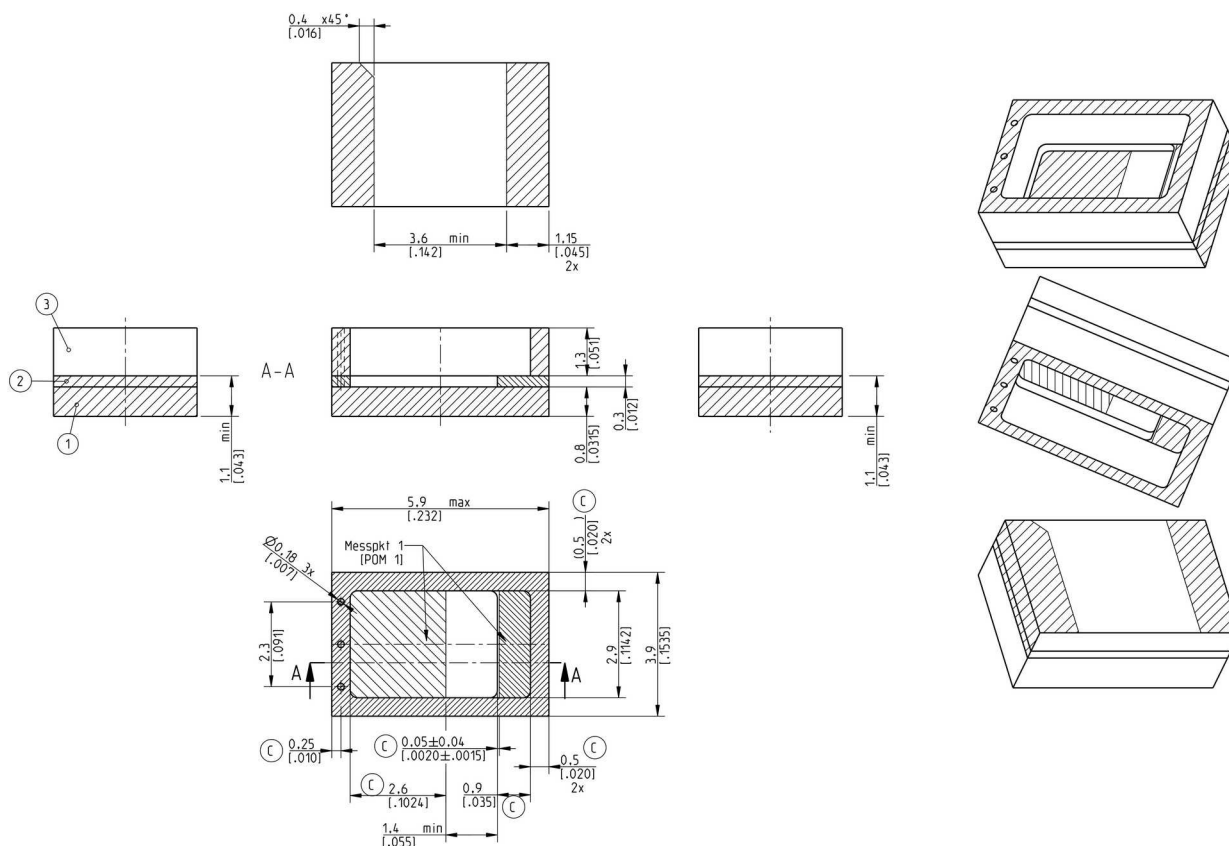
The AVR-EB4-B mainframe provides pulsed voltages of up to 240V to the test jig. For this reason, the output is automatically disabled when the test jig lid is open. The lid must be closed to obtain measurements.

 Shielded cabling should be used for all connections to the "IN" and "OUT" terminals on the test jig, and the "OUT" connector on the mainframe.

 When used properly (with $R_C = 50$ Ohms), the maximum voltage on the OUT terminal will be 24V, approximately. However, if R_C is not connected, the maximum voltage will at the OUT terminal may be as high as 240V. Avoid feeding this output directly into an oscilloscope. Always use a probe or an attenuator!

TEST JIG MECHANICAL ASPECTS

The AVX-TRR-TESB test jig is designed to accept the customer-specified ceramic package shown below:



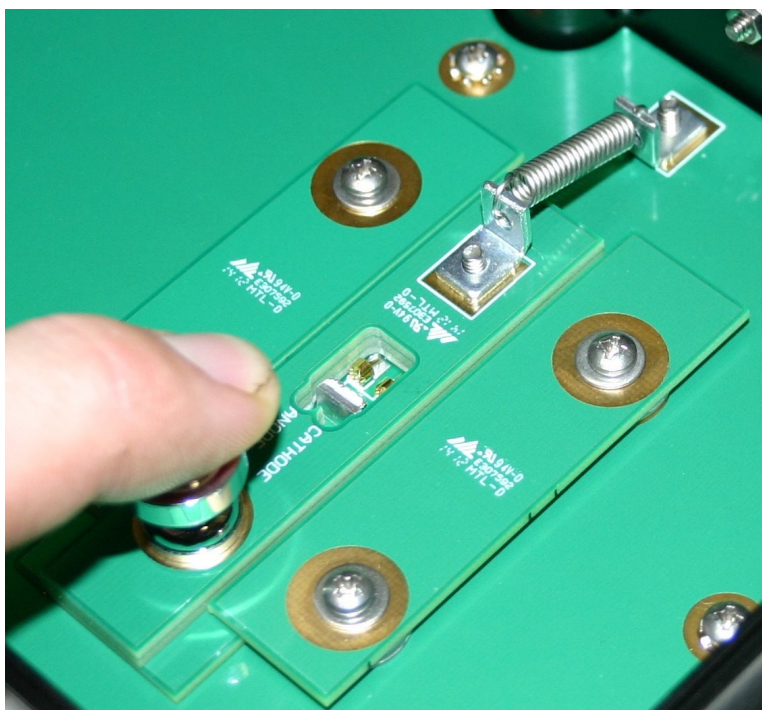
Probe points on the jig contact the two 1.15 x 3.9 mm pads on the flat bottom surface of the package. One of these pads must connect internally to the device anode, and one to the device cathode.

The circuit board is constructed from “high Tg” FR4 epoxy (Tg = 170°C).

The AVX-TRR-TESB test jig is shown below:

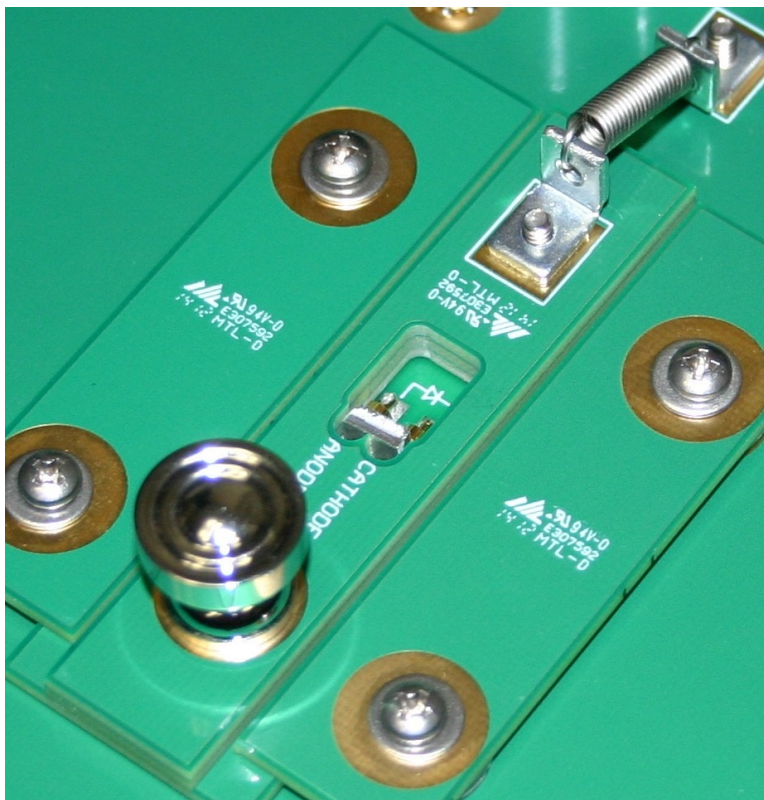


The DUT is installed by pulling back on the chrome knob, as shown below:



The DUT is then placed in the area immediately in front of the two fixed probe points, as shown in the photo above. Then slowly release the chrome knob, allowing the

spring-loaded PCB to push the DUT into position against the two probe points, as shown below. The PCB silk-screening shows the proper device positioning.



The anode pad must contact the left probe point, and the cathode pin must contact the right probe point.

The instrument and the DUT will not be damaged if the diode is installed with the incorrect orientation (i.e., with the anode and cathode reversed). However, incorrect waveforms will be generated.

The IN, OUT, and CONTROL connectors are on the rear of the jig, below the hinges:



SAFETY INTERLOCK

The AVX-TRR-TESB contains safety interlock devices, for use with the AVR-EB4-B mainframe. The DB-9 female "CONTROL" connector should be connected to the corresponding connector on the AVR-EB4-B mainframe using the straight-through DB-9 cable supplied with the AVR-EB4-B.

The DB9 "CONTROL" connector pinout is as follows:

Pin 1 - To test jig switch 1.

Pin 2 - To test jig switch 2.

Pin 5 - Ground.

Pin 6 - To test jig switch 1.

Pin 7 - To test jig switch 2.

Pin 9 - Safety sensor power supply (+15V through 680 Ohms).

When the test jig lid is safely closed, Pin 1 is shorted to Pin 6, and Pin 2 is shorted to Pin 7. Switch 1 is a passive mechanical switch. Switch 2 is an active photosensor, which requires power from Pin 9.

WIRING DIAGRAM

